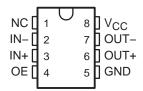
SLCS002D - JUNE 1983 - REVISED AUGUST 2003

- Operates From a Single 5-V Supply
- 0-V to 5.5-V Common-Mode Input Voltage Range
- Self-Biased Inputs
- Complementary 3-State Outputs
- Enable Capability
- Hysteresis . . . 5 mV Typ
- Response Times . . . 25 ns Typ

D, P, PS, OR PW PACKAGE (TOP VIEW)



NC-No internal connection

description/ordering information

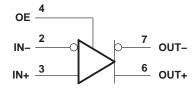
The TL712 is a high-speed comparator fabricated with bipolar Schottky process technology. The circuit has differential analog inputs and complementary 3-state TTL-compatible logic outputs with symmetrical switching characteristics. When the output enable (OE) is low, both outputs are in the high-impedance state. This device operates from a single 5-V supply and is useful as a disk memory read-chain data comparator.

ORDERING INFORMATION

TA	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING	
	PDIP (P)	Tube of 50	TL712CP	TL712CP	
	SOIC (D)	Tube of 75	TL712CD	TI 7400	
000 to 7000		Reel of 2500	TL712CDR	TL712C	
0°C to 70°C	SOP (PS)	Reel of 2000	TL712CPSR	T712	
	TSSOP (PW)	Tube of 150	TL712CPW	T740	
		Reel of 2000	TL712CPWR	T712	

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

symbol (positive logic)

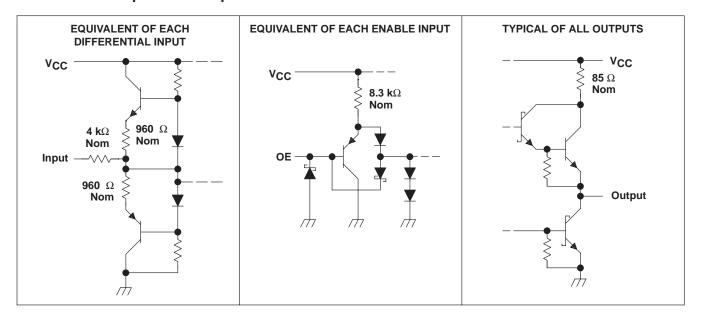




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schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC} (see Note 1)		$. \dots \dots \pm 25 \ V \\ \dots \dots \pm 25 \ V$
Low-level output current, I_{OL} Package thermal impedance, θ_{JA} (see Notes 3 and 4)		50 mA 97°C/W 85°C/W
	PW package	
Operating virtual junction temperature, T _J Lead temperature 1,6 mm (1/16 inch) from case for 10 Storage temperature range, T _{stg}) seconds	260°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the "recommended operating conditions" section of this specification is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential voltages, are with respect to the network ground.
 - 2. Differential voltage values are at IN+ with respect to IN -.
 - 3. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
 - 4. The package thermal impedance is calculated in accordance with JESD 51-7.



recommended operating conditions

		MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.75	5	5.25	V
VIC	Common-mode input voltage	0		5.5	V
ІОН	High-level output current			-1	mA
lOL	Low-level output current			16	mA
TA	Operating free-air temperature	0		70	°C

electrical characteristics at V_{CC} = 5 V, T_A = 25 $^{\circ}C$

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
VT	Threshold voltage (V _{T+} and V _{T-})	V _{ICR} = 0 to 5 V		-100†		100	mV
V _{hys}	Hysteresis (V _{T+} – V _{T-})				5	·	mV
Vон	High-level output voltage	$V_{ID} = 100 \text{ mV},$	$I_{OH} = -1 \text{ mA}$	2.7	3.5		V
VOL	Low-level output voltage	$V_{ID} = -100 \text{ mV},$	$I_{OL} = 16 \text{ mA}$		0.4	0.5	V
loz	Off-state output current	V _O = 2.4 V				-20	μΑ
II	Enable current	V _I = 5.5 V				100	μΑ
lн	High-level enable current	V _{IH} = 2.7 V				20	μΑ
Ι _Ι L	Low-level enable current	V _{IL} = 0.4 V				-360	μΑ
rį	Differential input resistance			4		·	kΩ
r _o	Output resistance					100	Ω
los	Short-circuit output current			-15		-85	mA
Icc	Supply current	$V_{ID} = 0$,	No load		17	20	mA

[†] The algebraic convention, where the more-negative limit is designated as minimum, is used in this data sheet for input threshold voltage levels only.

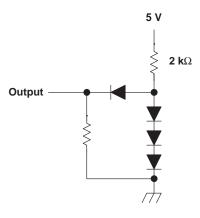
switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TE	TYP	UNIT	
tPLH	Propagation delay time, low-to-high-level output	TTL load.	See Note 5 and Figure 1	25	ns
tPHL	Propagation delay time, high-to-low-level output	1 1 L 10au,	i, See Note 5 and Figure 1	25	ns

NOTE 5: The response time specified is for a 100-mV input step with 5-mV overdrive (105 mV total) and is the interval between the input step function and the instant when the output crosses 2.5 V.



PARAMETER MEASUREMENT INFORMATION



NOTE A: All diodes are 1N4148 or equivalent.

Figure 1. TTL Output Load Circuit

TYPICAL CHARACTERISTICS

OUTPUT RESPONSE FOR VARIOUS INPUT OVERDRIVE VOLTAGES

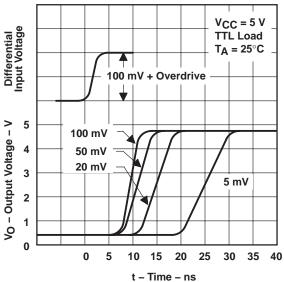


Figure 2

OUTPUT RESPONSE FOR VARIOUS INPUT OVERDRIVE VOLTAGES

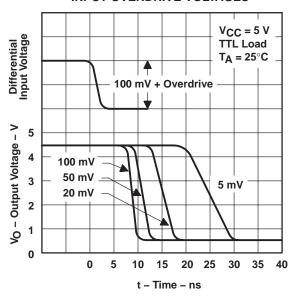


Figure 3

TYPICAL CHARACTERISTICS

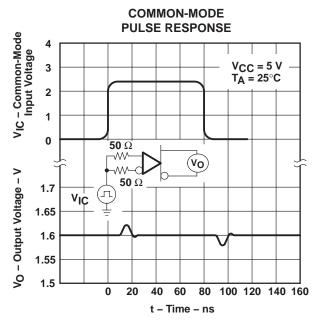
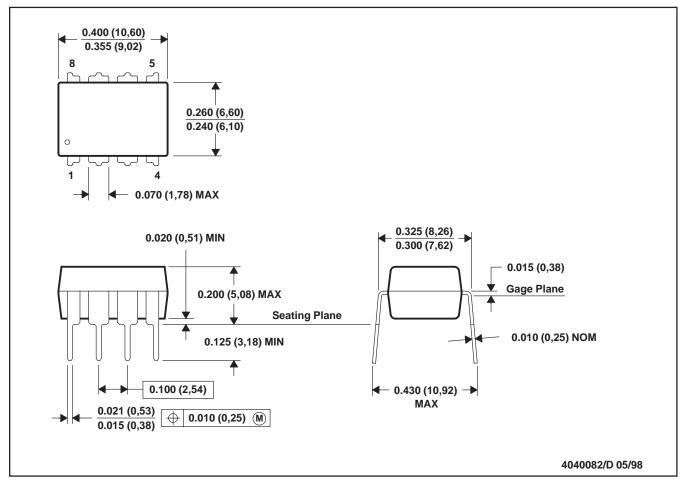


Figure 4

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE



NOTES: A. All linear dimensions are in inches (millimeters).

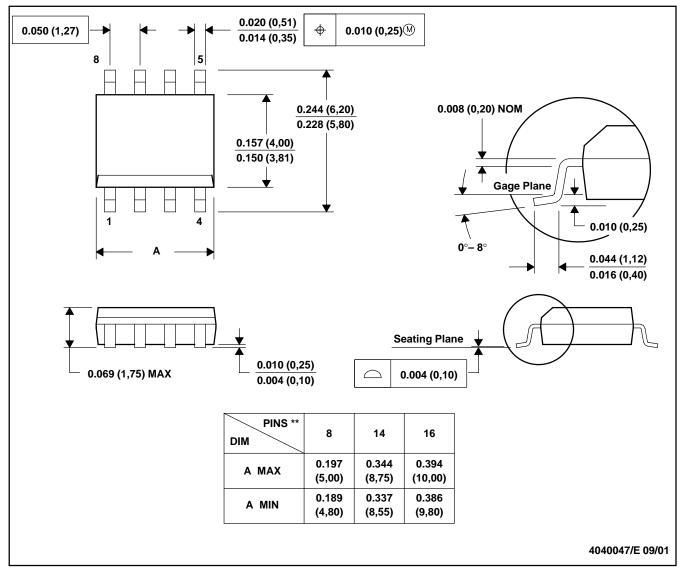
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001

For the latest package information, go to http://www.ti.com/sc/docs/package/pkg_info.htm

D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN

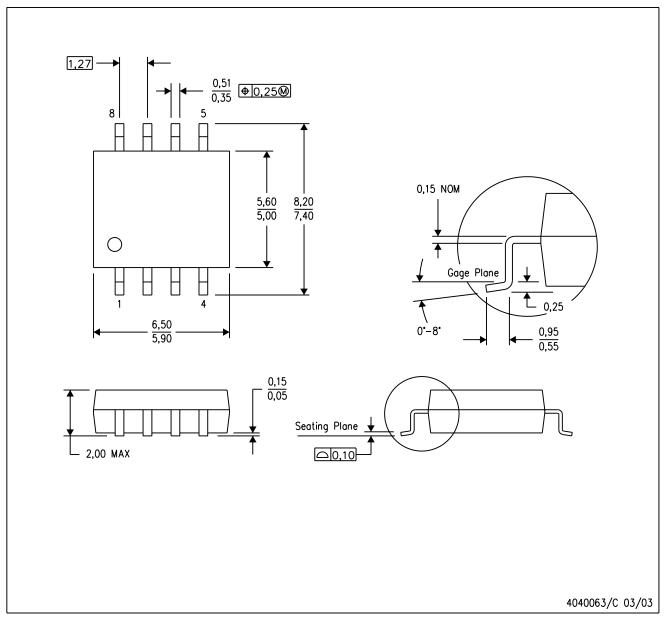


NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

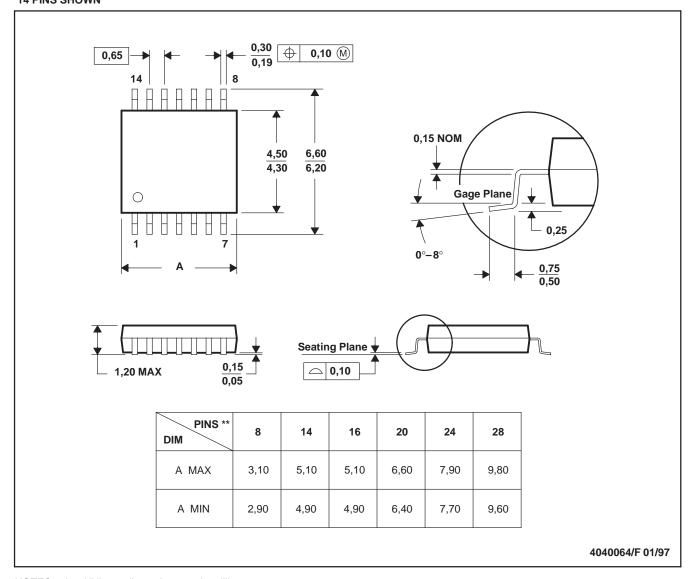
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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